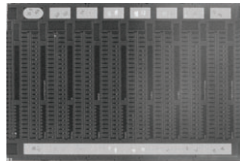
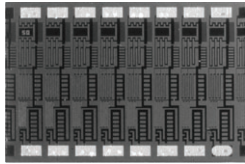




Wire Bondable Thin Film Resistor Arrays



Product may not be to scale

The CLA and CLB resistor arrays are the hybrid equivalent to the eight resistor common connection and isolated networks available in sips or dips. The resistors are spaced on 0.010" centers resulting in minimal space requirements.

These chips are manufactured using Vishay Electro-Films (EFI) sophisticated thin film equipment and manufacturing technology. The CLA and CLBs are 100 % electrically tested and visually inspected to MIL-STD-883.

FEATURES

- Wire bondable
- Up to 12 equal value resistors
- For case see Part Dimensions table
- Resistance range: 20 Ω to 1 MΩ
- Excellent TCR tracking
- Resistor material: tantalum nitride, self-passivating
- Oxidized silicon substrate for good power dissipation
- Custom values and pad geometries available
- Moisture resistant
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



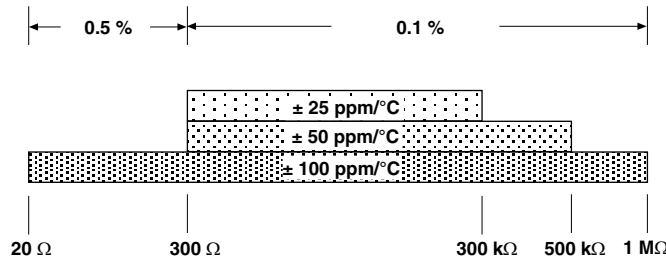
RoHS COMPLIANT HALOGEN FREE GREEN (5-2008)

APPLICATIONS

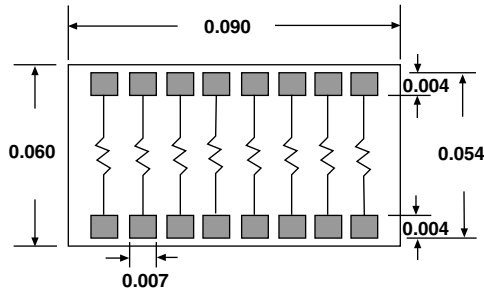
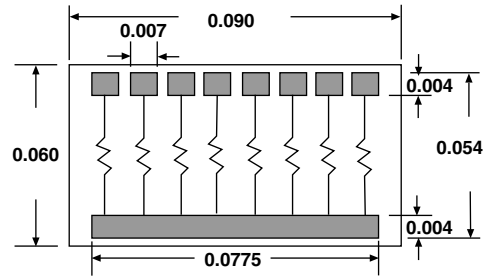
The CLA and CLB thin film resistor arrays are designed for hybrid packages requiring up to twelve resistors of the same resistance value and tolerance, as well as excellent TCR tracking. For such hybrids, they afford great savings in cost and space.

TEMPERATURE COEFFICIENT OF RESISTANCE, VALUES, AND TOLERANCES		
PARAMETER	VALUE	UNIT
Total Resistance Range	20 to 1M	Ω
Standard Tolerances	± 0.1, ± 0.5	%
TCR	± 25, ± 50, ± 100	ppm/°C

Tightest Standard Tolerance Available



STANDARD ELECTRICAL SPECIFICATIONS		
PARAMETER	VALUE	UNIT
TCR Tracking Spread	± 5	ppm/°C
Noise, MIL-STD-202, Method 308 100 Ω to 250 kΩ < 100 Ω or > 251 kΩ	-35 typ. -20 typ.	dB
Moisture Resistance, MIL-STD-202, Method 106	± 0.5 max. ΔR/R	%
Stability, 1000 h, +125 °C, 25 mW Absolute Ratio	± 0.25 max. ΔR/R ± 0.05 max. ΔR/R	%
Operating Temperature Range	-55 to +125	°C
Thermal Shock, MIL-STD-202 Method 107, Test Condition F	± 0.1 max. ΔR/R	%
High Temperature Exposure, ± 150 °C, 100 h	± 0.2 max. ΔR/R	%
Dielectric Voltage Breakdown	200	V
Insulation Resistance	10 ¹² min.	Ω
Operating Voltage	100	V
DC Power Rating at +70 °C (Derated to Zero at 175 °C)	0.050 per resistor	W
5 x Rated Power Short-Time Overload, +25 °C, 5 s	± 0.1 % max. ΔR/R	%

DIMENSIONS in inches

CLA 8 Cell

CLB 8 Cell

DIMENSIONS in inches					
# OF RES.	03	04	06	08	12
CLA	0.060 x 0.060 ± 0.003	0.050 x 0.060 ± 0.003	0.069 x 0.060 ± 0.003	0.090 x 0.060 ± 0.003	0.130 x 0.060 ± 0.003
CLB	0.060 x 0.060 ± 0.003	0.050 x 0.060 ± 0.003	0.069 x 0.060 ± 0.003	0.090 x 0.060 ± 0.003	0.130 x 0.060 ± 0.003

MECHANICAL SPECIFICATIONS	
PARAMETER	
Chip Size	See Dimensions table above
Chip Thickness	0.010" ± 0.002" (0.254 mm ± 0.05 mm)
Chip Substrate Material	Oxidized silicon, 10 kÅ minimum SiO ₂
Resistor Material	Tantalum nitride, self-passivating
Bonding Pads	0.004" x 0.007" (0.10 mm x 0.178 mm)
Number of Top Pads	CLA - 16 CLB - 9
Pad Material	10 kÅ minimum aluminum
Backing	None, lapped semiconductor silicon

GLOBAL PART NUMBER INFORMATION												
Global Part Number: CLA083000FFKANHWS												
Global Part Number Description: CLA 8 Res 3K 1%, 100 ppm/°C, Al terminations, no back metal, class H WS												
<div style="display: flex; justify-content: space-around; font-weight: bold; font-size: 1.2em;"> CLA0830000FFKANHWS </div>												
MODEL	TYPE	RESISTORS	RES.	RES. MULTIPLIER CODE	TOL. CODE	RATIO TOL.	TCR (ppm/°C)	TERM.	BACK METAL	VISUAL CLASS	PACKAGING CODE	
CL	A = isolated B = bussed	03 04 05 06 07 08 09 10 11 12	First 4 digits are significant figures of resistance	B = 0.01 A = 0.1 0 = 1 1 = 10 2 = 100 3 = 1000	B = 0.1 % C = 0.25 % D = 0.5 % F = 1.0 % G = 2.0 % J = 5.0 % K = 10.0 %	B = 0.1 % F = 1.0 % N = none	E = ± 25 C = ± 50 K = ± 100 M = ± 250	G = Au A = Al	G = Au N = none	H = class H K = class K	WS = waffle pack, 100 min., 1 mult.	



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.